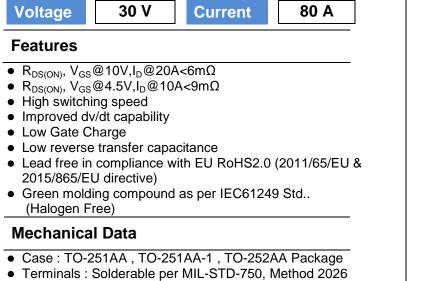
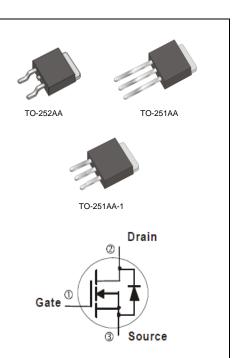


## 30V N-Channel Enhancement Mode MOSFET



- TO-251AA Approx. Weight : 0.0104 ounces, 0.297grams
- TO-251AA-1 Approx. Weight : 0.0118 ounces, 0.336grams
- TO-252AA Approx. Weight : 0.0105 ounces, 0.297grams



### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	<u>+</u> 20	V	
Continuous Drain Current	T <sub>C</sub> =25°C	l <sub>D</sub>	80	A	
	T <sub>c</sub> =100°C		50		
Pulsed Drain Current (Note 1)	T <sub>C</sub> =25°C	I <sub>DM</sub>	320		
Power Dissipation	T <sub>c</sub> =25°C	Po	55	W	
	T <sub>C</sub> =100°C		22		
Continuous Drain Current	T <sub>A</sub> =25°C	I <sub>D</sub>	15	А	
	T <sub>A</sub> =70°C		12	А	
Power Dissipation	T <sub>A</sub> =25°C	5	2.0	W	
Power Dissipation	T <sub>A</sub> =70°C	Pd	1.3		
Single Pulse Avalanche Energy (Note 6)		E <sub>AS</sub>	80	mJ	
Operating Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~150	°C	
Typical Thermal Resistance (Note 4,5)	Junction to Case	$R_{ extsf{ heta}JC}$	2.3	°C/W	
	Junction to Ambient	$R_{\thetaJA}$	62.5		

• Limited only By Maximum Junction Temperature





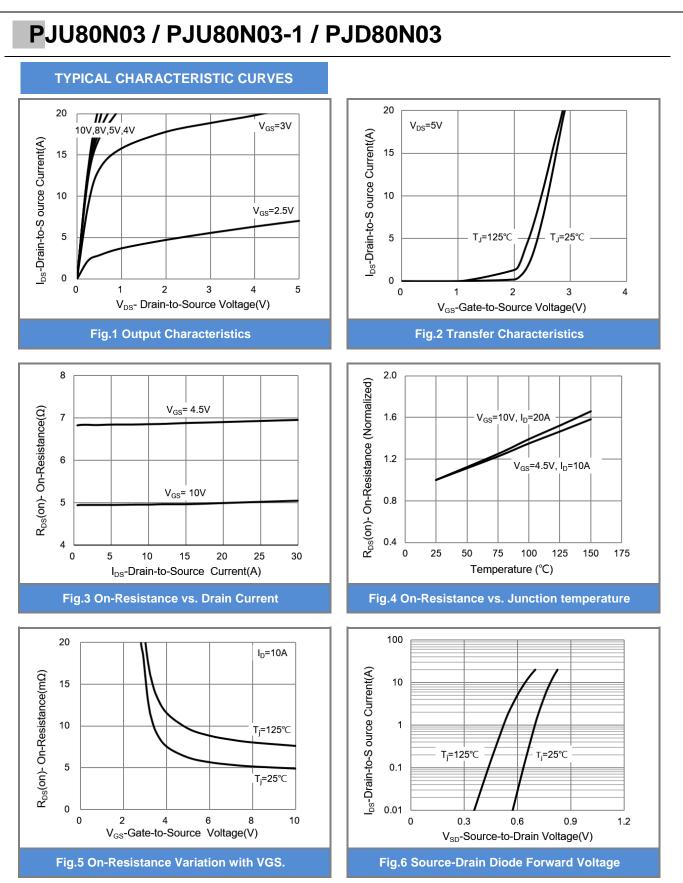
## **Electrical Characteristics** ( $T_A=25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V,I <sub>D</sub> =250uA	30	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250$ uA	1.0	1.6	2.5	V
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V,I <sub>D</sub> =20A	-	5.0	6	mΩ
		V <sub>GS</sub> =4.5V,I <sub>D</sub> =10A	-	6.6	9	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1.0	uA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = <u>+</u> 20V,V <sub>DS</sub> =0V	-	-	<u>+</u> 100	nA
Dynamic (Note 7)		•				
Total Gate Charge	Qg	V <sub>DS</sub> =15V, I <sub>D</sub> =20A, V <sub>GS</sub> =4.5V <sup>(Note 2,3)</sup>	-	12	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	3.8	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	4.3	-	
Input Capacitance	Ciss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,	-	1323	-	pF
Output Capacitance	Coss		-	219	-	
Reverse Transfer Capacitance	Crss	f=1.0MHZ	-	136	-	
Turn-On Delay Time	td <sub>(on)</sub>	$V_{DS}$ =15V,RL=1 $\Omega$ , $V_{GS}$ =10V, R <sub>G</sub> =3.3 $\Omega$ (Note 2,3)	-	5.0	-	ns
Turn-On Rise Time	tr		-	42	-	
Turn-Off Delay Time	td <sub>(off)</sub>		-	36	-	
Turn-Off Fall Time	t <sub>f</sub>		-	5.5	-	
Drain-Source Diode	•		•	•	•	
Maximum Continuous Drain-Source				-	80	A
Diode Forward Current	I <sub>S</sub>		-			
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =1A,V <sub>GS</sub> =0V	-	0.83	1.0	V

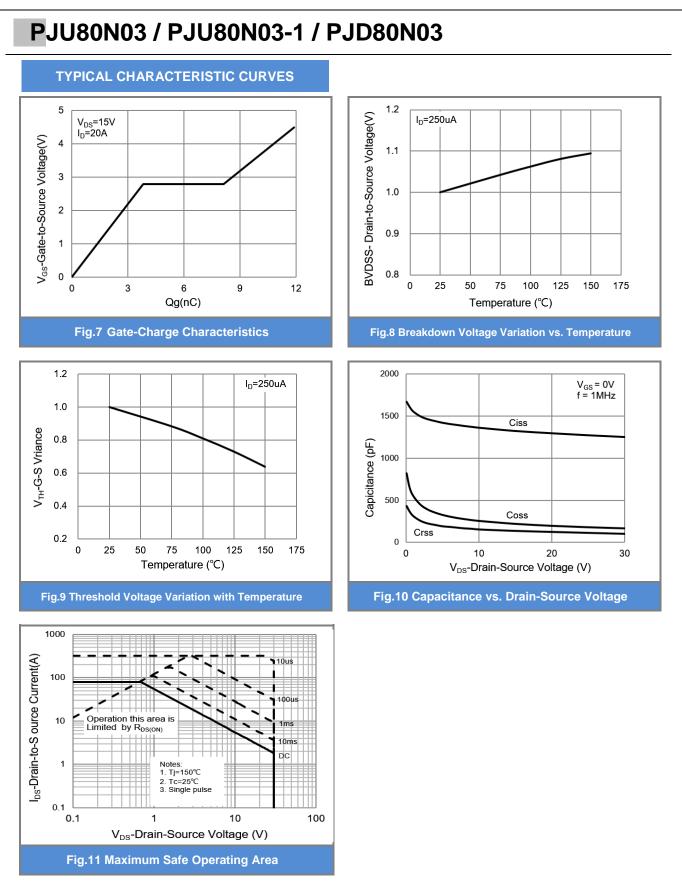
NOTES :

- 1. Pulse width <300us, Duty cycle <2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Repetitive rating, pulse width limited by junction temperature TJ(MAX)=150°C. Ratings are based on low frequency and duty cycles to keep initial TJ =25°C.
- 4. The maximum current rating is package limited.
- 5. R<sub>®JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 6. The test condition is L=0.1mH,  $I_{AS}$ =40A,  $V_{DD}$ =25V,  $V_{GS}$ =10V
- 7. Guaranteed by design, not subject to production testing.

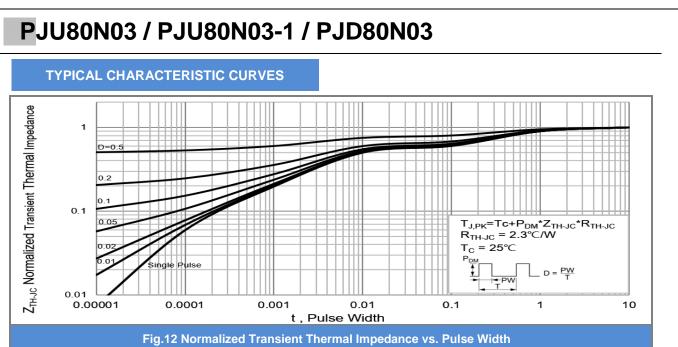






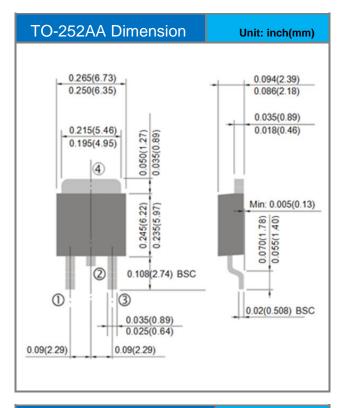


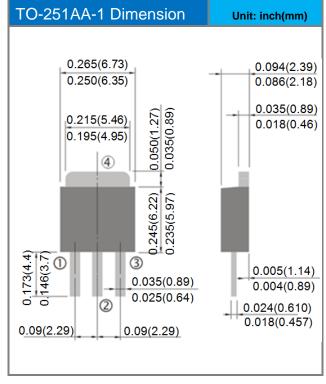


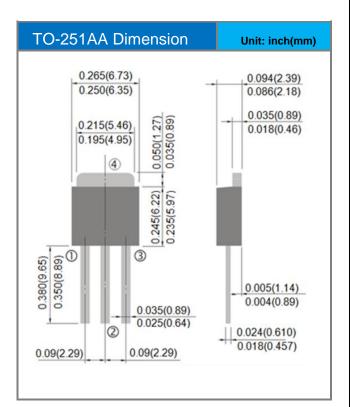




#### **Packaging Information**





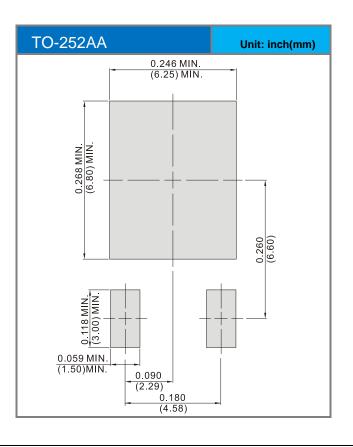




#### PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing Type	Marking	Version
PJU80N03_T0_00001	TO-251AA	80pcs / Tube	U80N03	Halogen free
PJU80N03-1_T0_00001	TO-251AA-1	80pcs / Tube	80N03	Halogen free
PJD80N03_L2_00001	TO-252AA	3,000pcs / 13" reel	D80N03	Halogen free

#### MOUNTING PAD LAYOUT







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